



#### 3A STANDARD RECOVERY BRIDGE RECTIFIER

### **Product Summary**

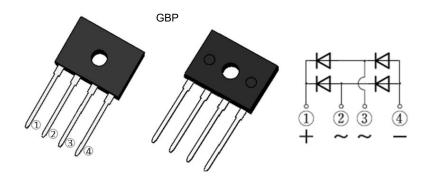
V <sub>RRM</sub> (V)	I <sub>F</sub> (A)	V <sub>F</sub> Max (V) @ I <sub>F</sub> = 1.5A	I <sub>R</sub> Max (μA)
600, 800, 1000	3	1.05	5

## **Mechanical Data**

- Package: GBP
- Package Material: Plastic Material, UL Flammability Classification 94V-0 (No Br. Sb, Cl)
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Polarity Indicator: Symbol Molded on Body.
- Weight: 1.33 grams (Approximate)

#### **Features**

- Glass Passivated Die Construction
- Rating to 1000V PRV
- Ideal for Printed Circuit Board
- Reliable Construction Utilizing Molded Plastic
- UL Recognized File # E95060
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/



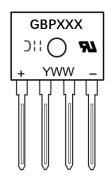
## **Ordering Information** (Note 4)

Orderable Part Number	Package	Packing		
		Qty.	Carrier	
GBP306	GBP	35	Tube	
GBP308	GBP	35	Tube	
GBP310	GBP	35	Tube	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

# **Marking Information**



GBPXXX = Product Type Marking Code

| Manufacturer's Code Marking
| YWW = Date Code Marking
| Y = Last Digit of Year (ex: 5 = 2025)
| WW = Week Code (01 to 53)



## Maximum Ratings (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	GBP306	GBP308	GBP310	Unit
Maximum Repetitive Peak Reverse Voltage		VRRM	600	800	1000	V
Maximum DC Blocking Voltage		V <sub>DC</sub>	600	800	1000	V
Maximum Average Rectified Output Current @T <sub>C</sub> = +100°C	With Heatsink Without Heatsink	I <sub>F(AV)</sub>	3.0 1.8		А	
Peak Forward Surge Current 8.3ms Single Half Sine Wave Superimposed on Rated Load	T <sub>J</sub> = +25°C T <sub>J</sub> = +125°C	IFSM	90 72		Α	
Peak Forward Surge Current 1.0ms Single Half Sine Wave Superimposed on Rated Load	T <sub>J</sub> = +25°C T <sub>J</sub> = +125°C	IFSM	200 160		Α	
I <sup>2</sup> t Rating for Fusing (t = 8.3ms)		I <sup>2</sup> t	33		A <sup>2</sup> s	
Operating Temperature Rage		TJ	-55 to + 150		°C	
Storage Temperature Rage		T <sub>STG</sub>	-55 to + 150		°C	

## **Electrical Characteristics**

Characteristic	Test Co	nditions	Symbol	Max	Unit
Forward Voltage	I <sub>F</sub> = 1.5A	T <sub>J</sub> = +25°C	VF	1.05	<b>V</b>
Leakage Current	V <sub>R</sub> at Rated	T <sub>J</sub> = +25°C T <sub>J</sub> = +125°C	I <sub>R</sub>	5 500	μΑ
Typical Junction Capacitance (Note 5)			СJ	25	pF

# **Thermal Characteristics**

Characteristic	Symbol	Тур	Unit
	RthJc	9	
Typical Thermal Resistance (Note 6)	RthJ∟	9	°C/W
	$RthJ_A$	20	

Notes:

<sup>5.</sup> Measured at 1.0MHz and applied reverse voltage of 4.0V DC.6. Thermal resistance junction to case, lead and ambient. Device mounted on 30mm x 30mm x 1mm Cu plate heatsink.



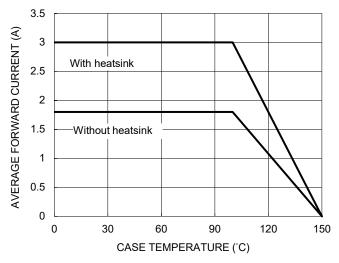


Figure 1. Forward Current Derating Curve

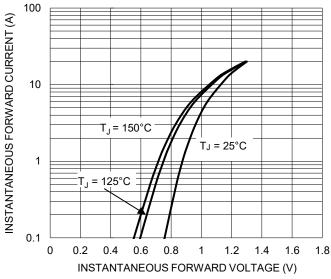


Figure 3. Typical Forward Characteristics

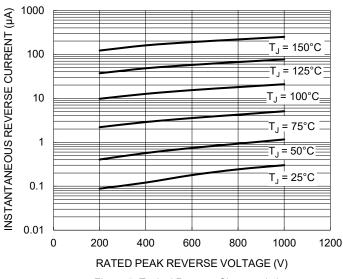


Figure 5. Typical Reverse Characteristics

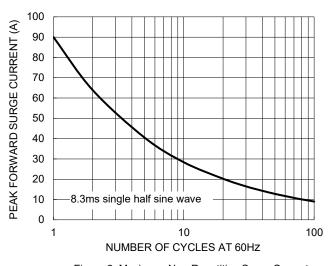


Figure 2. Maximum Non-Repetitive Surge Current

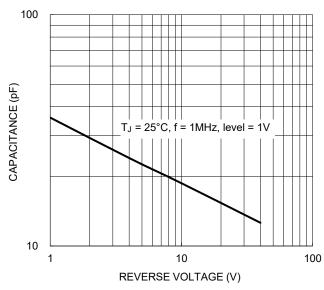


Figure 4. Typcial Junction Capacitance

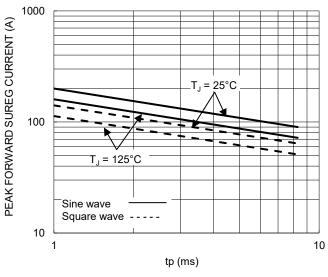


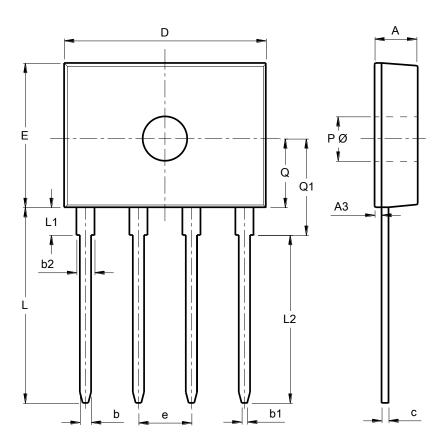
Figure 6. Non-Repetitive Surge Current



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### GBP



GBP						
Dim	Min	Max	TYP			
Α	2.90	3.30	3.10			
A3	0.30	0.70	0.50			
b	0.76	0.86	0.81			
b1	0.35	0.45	0.40			
b2	1.20	1.40	1.30			
С	0.40	0.60	0.50			
D	14.20	14.70	14.50			
Е	10.10	10.70	10.40			
е	3.71	3.91	3.81			
_	13.80	14.40	14.10			
L1	1.80	2.20	2.00			
L2	12.10 REF					
PØ	3.20 REF					
Q	4.65	5.25	4.95			
Q1	6.65	7.25	6.95			
All Dimensions in mm						



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